HIGH LINEARITY/DRIVER AMPLIFIER

RoHS Compliant & Pb-Free Product Package Style: QFN, 12-Pin, 3 x 3

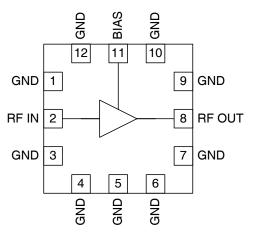


Features

- 500MHz to 2000MHz
- +44.0dBm Output IP3
- +14.0dB Gain at 850MHz
- +11.4dBm Input P1dB at 850MHz
- 3.4dB Noise Figure at 850 MHz
- Single 5V Power Supply

Applications

- Basestation Applications
- Cellular and PCS Systems
- CDMA, W-CDMA Systems
- GSM/EDGE Systems
- Final PA for Low-Power Applications



Functional Block Diagram

Product Description

The RF3223 is a high-efficiency GaAs Heterojunction Bipolar Transistor (HBT) amplifier packaged in a low-cost surface-mount package. This amplifier is ideal for use in applications requiring high-linearity and low noise figure over the 500MHz to 3GHz frequency range. The RF3223 operates from a single 5V power supply, and is assembled in an economical 3mmx3mm QFN package.

Ordering Information

RF3223 High Linearity/Driver Amplifier
RF3223PCBA-41X Fully Assembled Evaluation Board

Optimum Technology Matching® Applied

| ☑ GaAs HBT | ☐ SiGe BiCMOS | ☐ GaAs pHEMT | ☐ GaN HEMT |
|---------------|---------------|--------------|------------|
| ☐ GaAs MESFET | ☐ Si BiCMOS | ☐ Si CMOS | |
| ☐ InGaP HBT | ☐ SiGe HBT | ☐ Si BJT | |



Absolute Maximum Ratings

| Parameter | Rating | Unit |
|-----------------------|--------------|------|
| RF Input Power | +20 | dBm |
| Device Voltage | -0.5 to +6.0 | V |
| Device Current | 250 | mA |
| Operating Temperature | -40 to +85 | °C |
| Storage Temperature | -40 to +150 | °C |



Caution! ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

RoHS status based on EU Directive 2002/95/EC (at time of this document revision).

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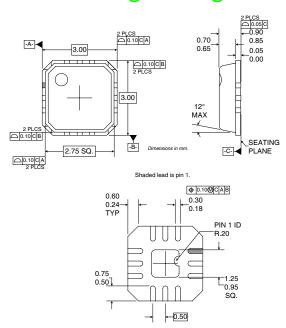
| Davomotov | Specification | | Unit | Condition | | |
|---|---------------|-------|------|-----------|--|--|
| Parameter | Min. | Тур. | Max. | Ullit | Condition | |
| Overall | | | | | V _{CC} =5V, RF _{IN} =-10dBm, Freq=850MHz, with Temp=25°C unless otherwise noted. | |
| AC Specifications | | | | | | |
| Frequency | 500 | | 2000 | MHz | | |
| Gain (Small Signal) | 12 | 14 | 15 | dB | | |
| Input VSWR | | 1.4 | 1.7 | SWR | | |
| Output VSWR | | 1.3 | | SWR | | |
| Reverse Isolation | 19 | 21 | | | | |
| Output IP3 | 41 | 45 | | dBm | F ₁ = 850MHz, F ₂ =851MHz | |
| Output P1dB | 23 | +24.5 | | dBm | | |
| Noise Figure | | 3.4 | 4.0 | dB | | |
| Thermal | | | | | I _{CC} =160 mA, P _{DISS} =0.913 W. (See Note) | |
| Theta _{JC} | | 75 | | °C/W | | |
| Maximum Measured Junction Temperature at DC Bias Conditions | | 154 | | °C | T _{CASE} =+85°C | |
| Mean Time To Failures | | 5500 | | years | T _{CASE} =+85 °C | |
| DC Specifications | | | | | | |
| Device Voltage | 4.5 | 5.0 | 5.5 | V | I _{CC} =160 mA | |
| Operating Current Range | 110 | 150 | 170 | mA | V _{CC} =5V | |

Note: The RF3223 must be operated at or below 175 mA in order to achieve the thermal performance listed above. While the RF3223 may be operated at higher bias currents, 175 mA is the recommended bias to ensure the highest possible reliability and electrical performance.



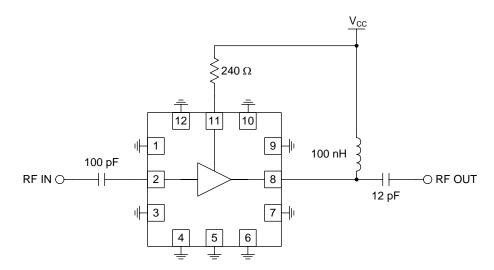
| Pin | Function | Description | Interface Schematic |
|-------------|----------|--|------------------------------------|
| 1 | GND | Ground connection. | |
| 2 | RF IN | RF input pin. This pin is not internally DC-blocked. A DC blocking capacitor suitable for the frequency of operation should be used. | To Bias Circuit RF IN RF OUT |
| 3 | GND | Ground connection. | |
| 4 | GND | Ground connection. | |
| 5 | GND | Ground connection. | |
| 6 | GND | Ground connection. | |
| 7 | GND | Ground connection. | |
| 8 | RF OUT | Amplifier output pin. This pin is an open-collector output. It must be biased to V_{CC} through a choke or matching inductor. This pin is typically matched to 50Ω with a shunt bias/matching inductor and series blocking/matching capacitor. Refer to application schematics. | See pin 2. |
| 9 | GND | Ground connection. | |
| 10 | GND | Ground connection. | |
| 11 | BIAS | This pin is used to control the bias current. An external resistor may be used to set the bias current for any V_{PD} voltage. Allows for trade-offs between IP3 versus noise figure and T_{MAX} . | |
| 12 | GND | Ground connection. | |
| Pkg Base | GND | Ground connection. Vias to ground required under the package base. | |

Package Drawing





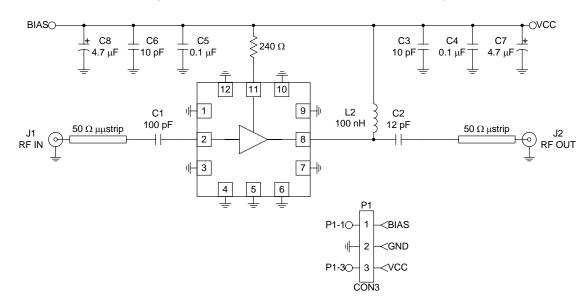
Application Schematic - 850 MHz





Evaluation Board Schematic

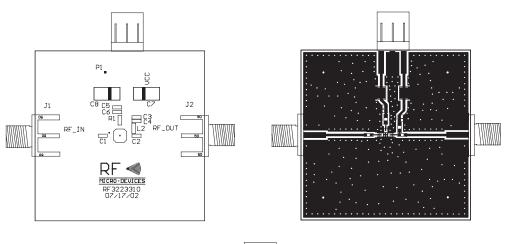
(Download Bill of Materials from www.rfmd.com.)

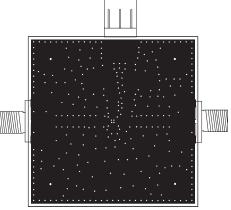




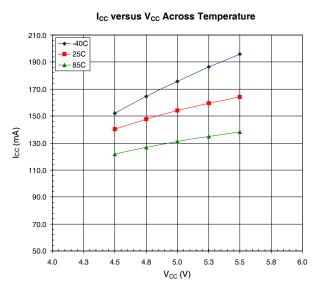
Evaluation Board Layout Board Size 1.5" x 1.5"

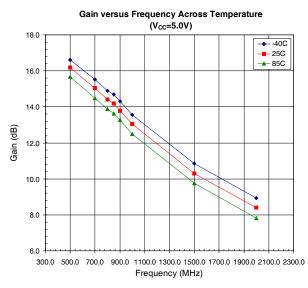
Board Thickness 0.032", Board Material FR-4

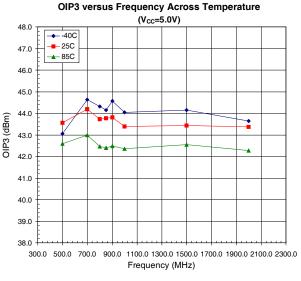


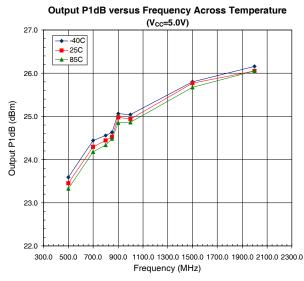


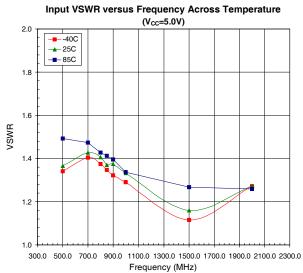


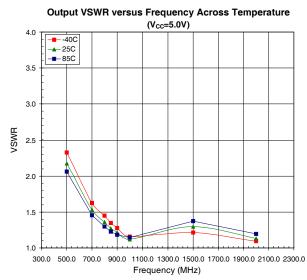










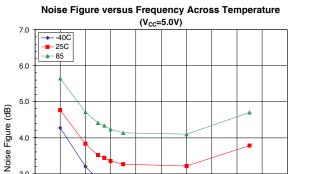


3.0

2.0

1.0





300.0 500.0 700.0 900.0 1100.0 1300.0 1500.0 1700.0 1900.0 2100.0 2300.0 Frequency (MHz)





